

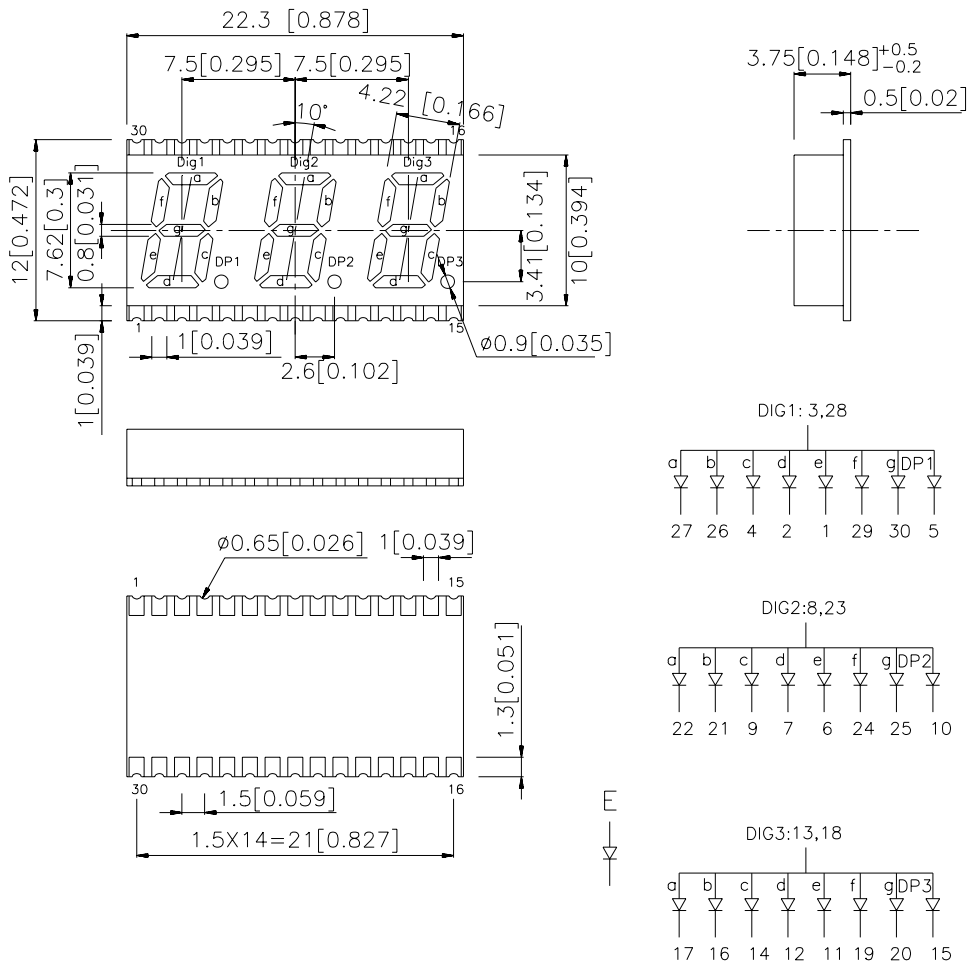
Features

- 0.3 INCH DIGIT HEIGHT.
- LOW CURRENT OPERATION.
- EXCELLENT CHARACTER APPEARANCE.
- I.C. COMPATIBLE.
- MECHANICALLY RUGGED.
- GRAY FACE, WHITE SEGMENT.
- PACKAGE: 800PCS/REEL.

Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

Package Dimensions & Internal Circuit Diagram



Selection Guide

| Part No. | Dice | Lens Type | Iv (ucd) @ 10 mA | | Description |
|--------------|--------------------------------|----------------|---------------------|------|------------------------------|
| | | | Min. | Typ. | |
| APBA03-41EWA | HIGH EFFICIENCY RED(GaAsP/GaP) | WHITE DIFFUSED | 1200 | 4210 | Common Anode.Rt.Hand Decimal |

Electrical / Optical Characteristics at T_A=25°C

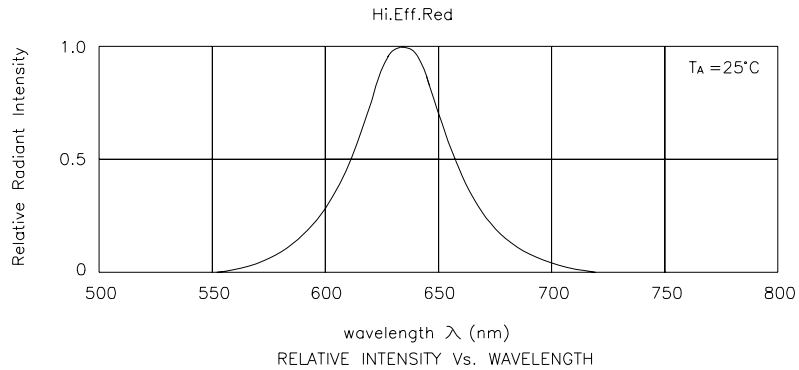
| Symbol | Parameter | Device | Typ. | Max. | Units | Test Conditions |
|-----------------------|--------------------------|---------------------|------|------|-------|---------------------------|
| λ_{peak} | Peak Wavelength | High Efficiency Red | 627 | | nm | I _F =20mA |
| λ_D | Dominate Wavelength | High Efficiency Red | 625 | | nm | I _F =20mA |
| $\Delta\lambda_{1/2}$ | Spectral Line Half-width | High Efficiency Red | 45 | | nm | I _F =20mA |
| C | Capacitance | High Efficiency Red | 15 | | pF | V _F =0V;f=1MHz |
| V _F | Forward Voltage | High Efficiency Red | 2.0 | 2.5 | V | I _F =20mA |
| I _R | Reverse Current | High Efficiency Red | | 10 | uA | V _R = 5V |

Absolute Maximum Ratings at T_A=25°C

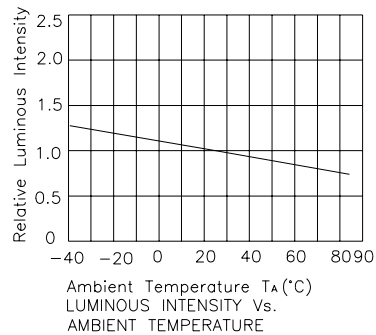
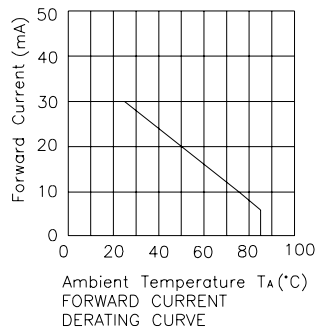
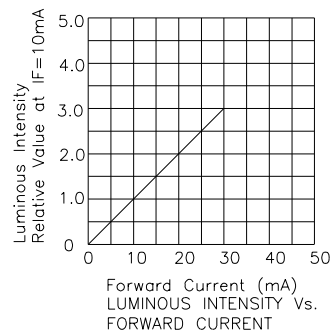
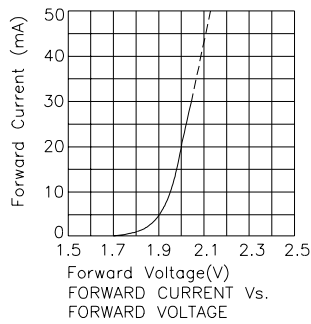
| Parameter | High Efficiency Red | Units |
|-------------------------------|---------------------|-------|
| Power dissipation | 105 | mW |
| DC Forward Current | 30 | mA |
| Peak Forward Current [1] | 160 | mA |
| Reverse Voltage | 5 | V |
| Operating/Storage Temperature | -40°C To +85°C | |

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

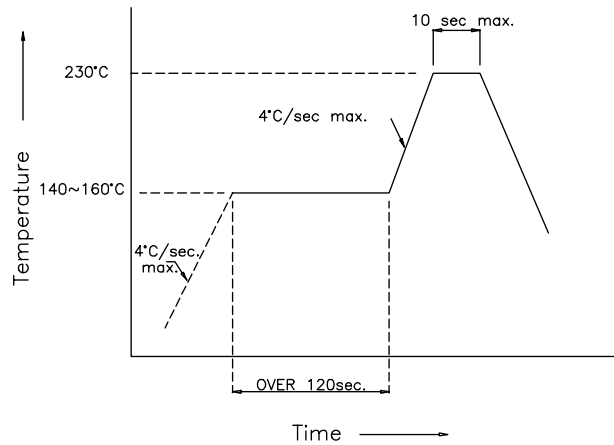


High Efficiency Red APBA03-41EWA

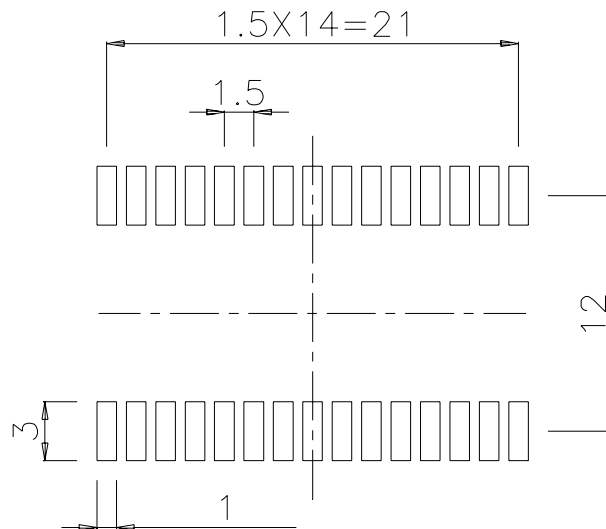


APBA03-41EWA SMT Reflow Soldering Instruction

Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern (Units : mm)



Tape Specification (Units : mm)

